



MICROCHIP PIC18F2458/2553/4458/4553

PIC18F2458/2553/4458/4553 Rev. B7 Silicon Errata

The PIC18F2458/2553/4458/4553 Rev. B7 parts you have received conform functionally to the Device Data Sheet (DS39887B), except for the anomalies described below. Any Data Sheet Clarification issues related to the PIC18F2458/2553/4458/4553 will be reported in a separate Data Sheet errata. Please check the Microchip web site for any existing issues.

Note: The "PIC18F2458/2553/4458/4553 Data Sheet" is supplemented by the "PIC18F2455/2550/4455/4550 Data Sheet" (DS39632). PIC18F2458/2553/4458/4553 features and specifications that are shared with the PIC18F2455/2550/4455/4550 devices are documented in the "PIC18F2455/2550/4455/4550 Data Sheet".

The following silicon errata apply only to PIC18F2458/2553/4458/4553 devices with these Device/Revision IDs:

Part Number	Device ID	Revision ID
PIC18F2458	0010 1010 011	0 0111
PIC18F2553	0010 1010 010	0 0111
PIC18F4458	0010 1010 001	0 0111
PIC18F4553	0010 1010 000	0 0111

The Device IDs (DEVID1 and DEVID2) are located at addresses 3FFFFEh:3FFFFFh in the device's configuration space. They are shown in binary in the format "DEVID2 DEVID1".

All of the issues listed here will be addressed in future revisions of the PIC18F2458/2553/4458/4553 silicon.

TABLE 1: EXAMPLE SPI MODE REQUIREMENTS (SLAVE MODE TIMING)

Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
70	TssL2sCH, TssL2sCL	\overline{SS} ↓ to SCK ↓ or SCK ↑ Input	3 Tcy	—	ns	

1. Module: MSSP

In SPI Slave mode with slave select enabled (SSPM<3:0> = 0100), the minimum time between the falling edge of the \overline{SS} pin and first SCK edge is greater than specified in parameter 70 in Table 28-17 and Table 28-18 of the "PIC18F2455/2550/4455/4550 Data Sheet" (DS39632). The updated specification is shown in bold in Table 1.

The minimum time between \overline{SS} pin low and an SSPBUF write is also 3 Tcy. If the falling edge of the \overline{SS} pin occurs greater than 3 Tcy, before the first SCK edge or loading SSPBUF, the peripheral will function correctly. Also, if SSPBUF is written prior to the \overline{SS} pin going low, the peripheral will function correctly.

Work around

None.

Date Codes that pertain to this issue:

All engineering and production devices.

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2. Module: MSSP

With MSSP in SPI Master mode, $F_{osc}/64$ or Timer2/2 clock rate and $CKE = 0$, a write collision may occur if SSPBUF is loaded immediately after the transfer is complete. A delay may be required after the MSSP Interrupt Flag bit, SSPIF, is set or the Buffer Full bit, BF, is set and before writing SSPBUF. If the delay is insufficiently short, a write collision may occur as indicated by the WCOL bit being set.

Work around

Add a software delay of one SCK period after detecting the completed transfer and prior to updating the SSPBUF contents. Verify the WCOL bit is clear after writing SSPBUF. If the WCOL is set, clear the bit in software and rewrite the SSPBUF register.

Date Codes that pertain to this issue:

All engineering and production devices.

3. Module: ECCP (PWM Mode)

When configured for half-bridge operation with dead band ($CCPxCON\langle 7:6 \rangle = 10$), the PWM output may be corrupted for certain values of the PWM duty cycle. This can occur when these additional criteria are also met:

- A non-zero dead-band delay is specified ($PDC6:PDC0 > 0$)
- The duty cycle has a value of 0 through 3, or $4n + 3$ ($n \geq 1$)

Work around

None.

Date Codes that pertain to this issue:

All engineering and production devices.

4. Module: Electrical Characteristics (BOR)

Certain operating conditions can move the effective Brown-out Reset (BOR) threshold outside of the range specified in the electrical characteristics of the device data sheet (parameter D005).

The BOR threshold has been observed to increase with some table read operations. BOR has been observed with 7 percent higher V_{DD} than the V_{BOR} value specified for a given BORV<1:0> setting.

Work around

None.

Date Codes that pertain to this issue:

All engineering and production devices.

5. Module: MSSP

If the application firmware is expecting to receive valid data – in either SPI Slave or Master mode – the firmware must read from the SSPBUF register before writing the next byte to transmit to SSPBUF.

If the firmware does not read from SSPBUF, the BF bit (SSPSTAT<0>) can still be set from the previous transaction. If the BF bit is set, the incoming data byte is blocked from transferring from the SSPSR Shift register to the SSPBUF register. If the firmware then reads from SSPBUF, the data read will not match the data most recently received on the SDI pin.

In the earlier silicon revision (B5), incoming data bytes received on the SDI pin are always transferred from SSPSR to SSPBUF, regardless of the state of the BF bit.

Work around

If the firmware expects to receive valid data, always clear the BF bit by reading from SSPBUF prior to writing to SSPBUF, even when the current data in SSPBUF is not important. Sample work around code, suitable for all silicon revisions, is given in Example 1 (Assembly language) and Example 2 (C language).

Date Codes that pertain to this issue:

All engineering and production devices.

EXAMPLE 1: SAMPLE ASSEMBLY CODE FOR TRANSFERRING SPI DATA

```
WriteSPI:
BCF    PIR1, SSPIF
MOVF   SSPBUF, w    ;Perform read, even if the data in SSPBUF is not important
MOVLW  0xA5         ;In this example, let's send "0xA5" to the other SPI device.
MOVWF  SSPBUF

WaitXmitComplete:
BTFSS  PIR1, SSPIF
BRA    WaitXmitComplete

MOVF   SSPBUF, w    ;The data received should be valid.
```

EXAMPLE 2: SAMPLE C CODE FOR TRANSFERRING SPI DATA

```
unsigned char WriteSPI(unsigned char ByteToSend)
{
    unsigned char TempVariable;

    PIR1bits.SSPIF = 0;
    TempVariable = SSPBUF;    // Reads from SSPBUF, ensures BF bit is clear before
    SSPBUF = ByteToSend;    // sending the next byte.

    while(!PIR1bits.SSPIF); // Wait until the transmission is complete.
    return SSPBUF;          // The data received should be valid.
}
```

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REVISION HISTORY

Rev A Document (8/2008)

Initial release of this document. Includes silicon issues 1-2 (MSSP), 3 (ECCP – PWM Mode), 4 (Electrical Characteristics – BOR) and 5 (MSSP).

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